

## **MDTE Series**

Wire Wound Molded SMD Power Inductors Size 32251B

#### **FEATURES**

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 $^{\circ}$ C

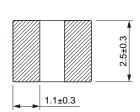
#### **APPLICATION**

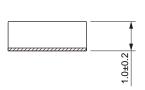
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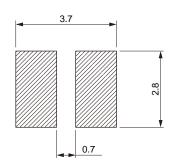
Dimensions: [mm]

Land Pattern: [mm]









# **Electrical Properties:**

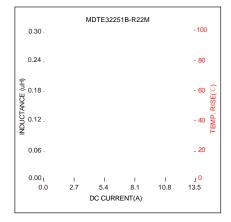
	Satura on	Satura on			
(µH)	(A)	(A)	(A)	(A)	(m )

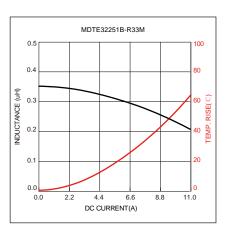
Saturation Current will cause L to drop approximately 30%

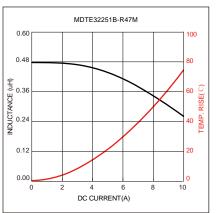
Temperature Rise Current: The actual value of DC current when the temperature rise is △T=40°C

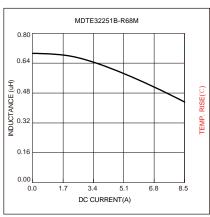


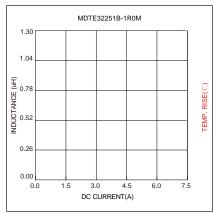
# Typical Electrical Characteristics:

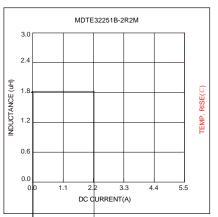


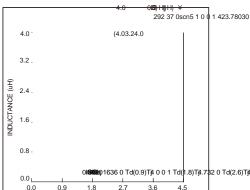












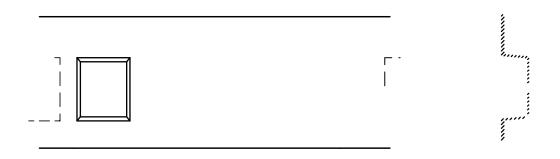




# Soldering Reflow:

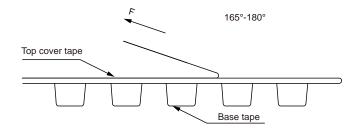
## Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE32251B	2.9± 0.1	3.6± 0.1	1.5± 0.1	4.0± 0.1	4.0± 0.1	8.0± 0.1	1.4± 0.1	1.75± 0.1	0.25± 0.05

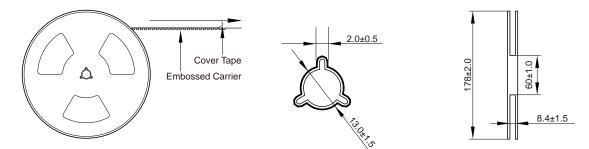
## Peel force of top cover tape:



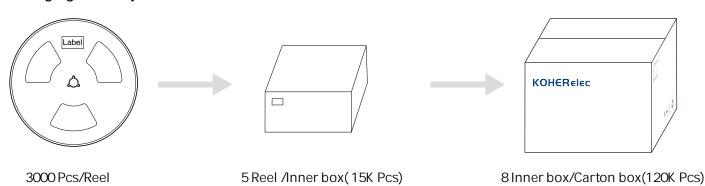
The peel force of top cover tape shall be between 0.1 to 0.98 N



### Reel Dimension: [mm]



### Packaging Quantity:



## Cautions and Warnings:

### Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

### **Operation Instructions:**

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer
  does.As a result customer shall be responsible for checking and confirming whether Koher product with the
  performance described in the product specification is suitable for using in customer's particular application or
  not.